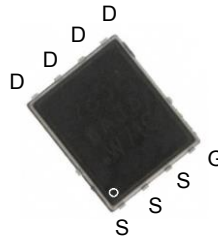
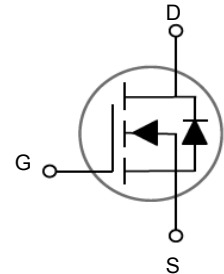


Main Product Characteristics

$V_{(BR)DSS}$	150V
$R_{DS(ON)}$	65mΩ
I_D	15A



PPAK5X6



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The SSFP3015 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

Absolute Maximum Ratings ($T_C=25^{\circ}C$ unless otherwise specified)

DUFLa YHf	Gna Vc`	FUj]b[I b]h
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	±25	V
Drain Current – Continuous ($T_C=25^{\circ}C$)	I_D	15	A
Drain Current – Continuous ($T_C=100^{\circ}C$)		9.5	A
Drain Current – Pulsed ¹	I_{DM}	60	A
Single Pulse Avalanche Energy ²	E_{AS}	242	mJ
Single Pulse Avalanche Current ²	I_{AS}	22	A
Power Dissipation ($T_C=25^{\circ}C$)	P_D	135	W
Power Dissipation – Derate above 25°C		1.08	W/°C
Storage Temperature Range	T_{STG}	-55 to +150	°C
Operating Junction Temperature Range	T_J	-55 to +150	°C

Thermal Characteristics

DUFLa YHf	Gna Vc`	Hrd"	AU "	I b]h
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	---	62	°C/W
Thermal Resistance Junction to Case	$R_{\theta JC}$	---	0.92	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	150	---	---	V
BV_{DSS} Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ\text{C}, I_D=1mA$	---	0.08	---	$V/^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=120V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=96V, V_{GS}=0V, T_J=125^\circ\text{C}$	---	---	30	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 25V, V_{DS}=0V$	---	---	± 100	nA
Dynamic Characteristics						
Static Drain-Source On-Resistance ³	$R_{DS(ON)}$	$V_{GS}=10V, I_D=6A$	---	52	65	m Ω
		$V_{GS}=6V, I_D=4A$	---	65	90	m Ω
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2	3	4	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		---	-2.5	---	$mV/^\circ\text{C}$
Switching Characteristics						
Total Gate Charge ^{3,4}	Q_g	$V_{DS}=30V, V_{GS}=10V, I_D=4A$	---	30	45	nC
Gate-Source Charge ^{3,4}	Q_{gs}		---	8.7	14	
Gate-Drain Charge ^{3,4}	Q_{gd}		---	8	15	
Turn-On Delay Time ^{3,4}	$T_{d(on)}$	$V_{DD}=30V, V_{GS}=10V, R_G=6\Omega, I_D=1A$	---	14.5	28	nS
Rise Time ^{3,4}	T_r		---	19.2	18	
Turn-Off Delay Time ^{3,4}	$T_{d(off)}$		---	33.6	60	
Fall Time ^{3,4}	T_f		---	22.8	25	
Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V, F=1MHz$	---	1790	3000	pF
Output Capacitance	C_{oss}		---	160	300	
Reverse Transfer Capacitance	C_{rss}		---	82	160	
Gate Resistance	R_g	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	---	1.4	2.8	Ω
Thermal Characteristics						
Continuous Source Current	I_S	$V_G=V_D=0V, \text{Force Current}$	---	---	15	A
Pulsed Source Current	I_{SM}		---	---	30	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$	---	---	1.2	V

Note:

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
2. $V_{DD}=-50V, V_{GS}=-10V, L=1mH, I_{AS}=-22A, R_G=25\Omega, \text{Starting } T_J=25^\circ\text{C}.$
3. The data tested by pulsed, pulse width $\leq 300\mu S$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.

Typical Electrical and Thermal Characteristic Curves

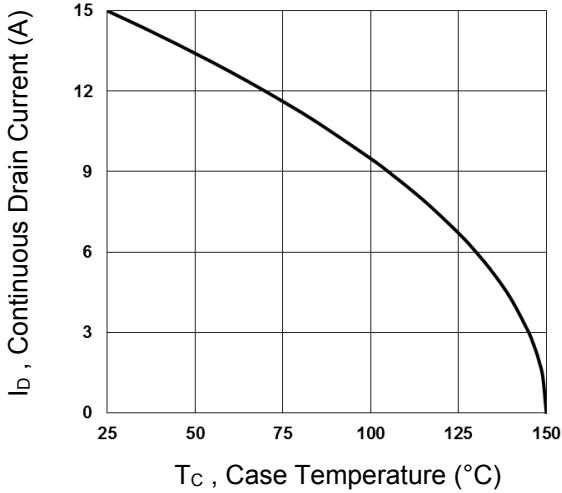


Fig.1 Continuous Drain Current vs. T_c

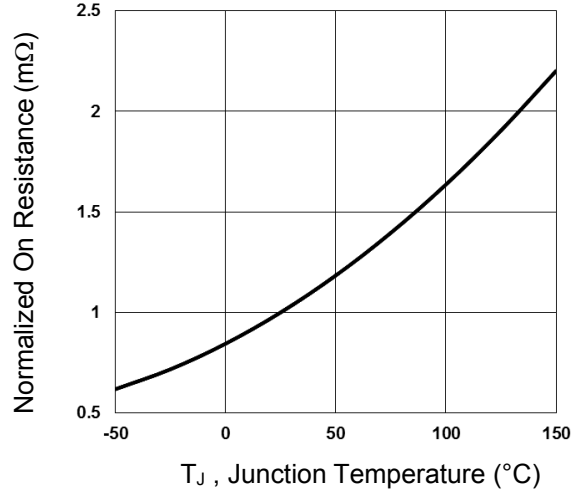


Fig.2 Normalized $R_{DS(ON)}$ vs. T_j

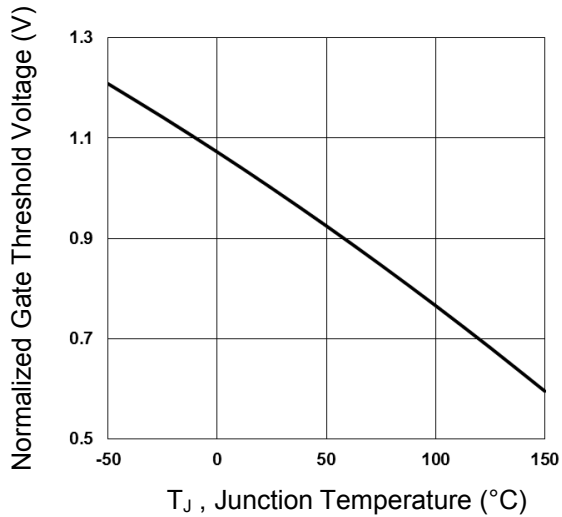


Fig.3 Normalized V_{th} vs. T_j

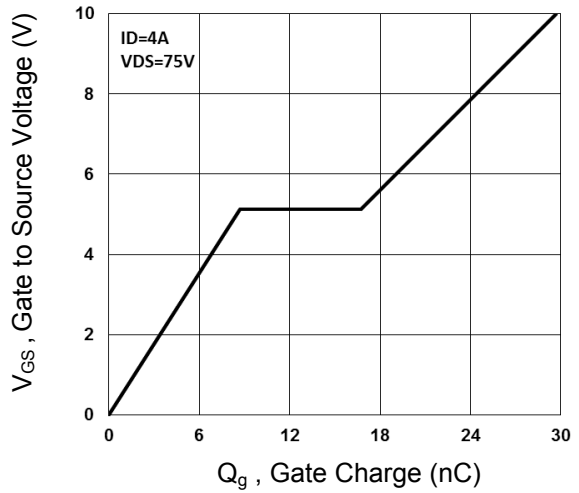


Fig.4 Gate Charge Characteristics

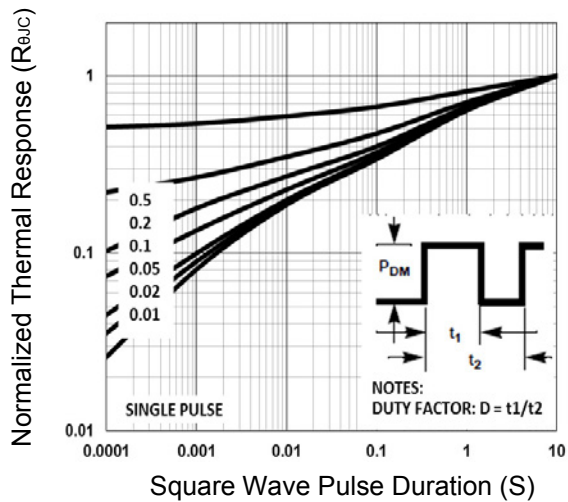


Fig.5 Normalized Transient Impedance

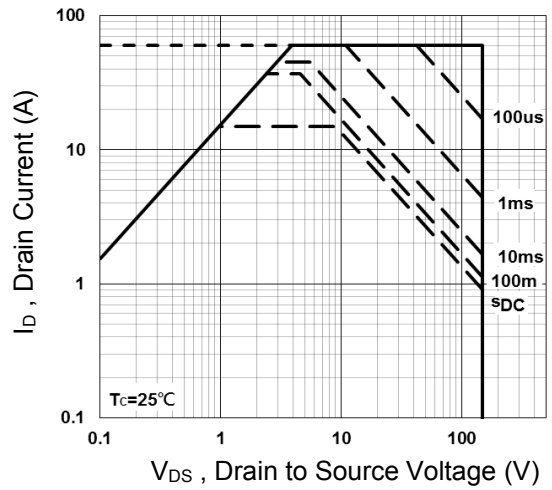


Fig.6 Maximum Safe Operation Area

Typical Electrical and Thermal Characteristic Curves

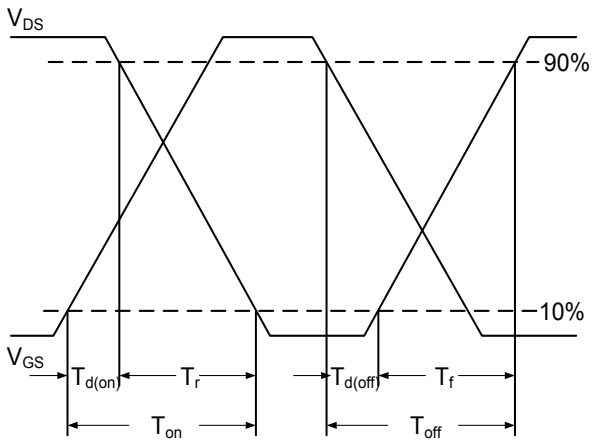


Fig.7 Switching Time Waveform

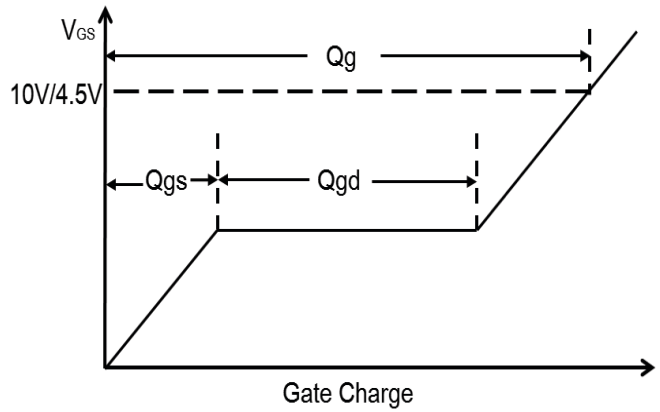
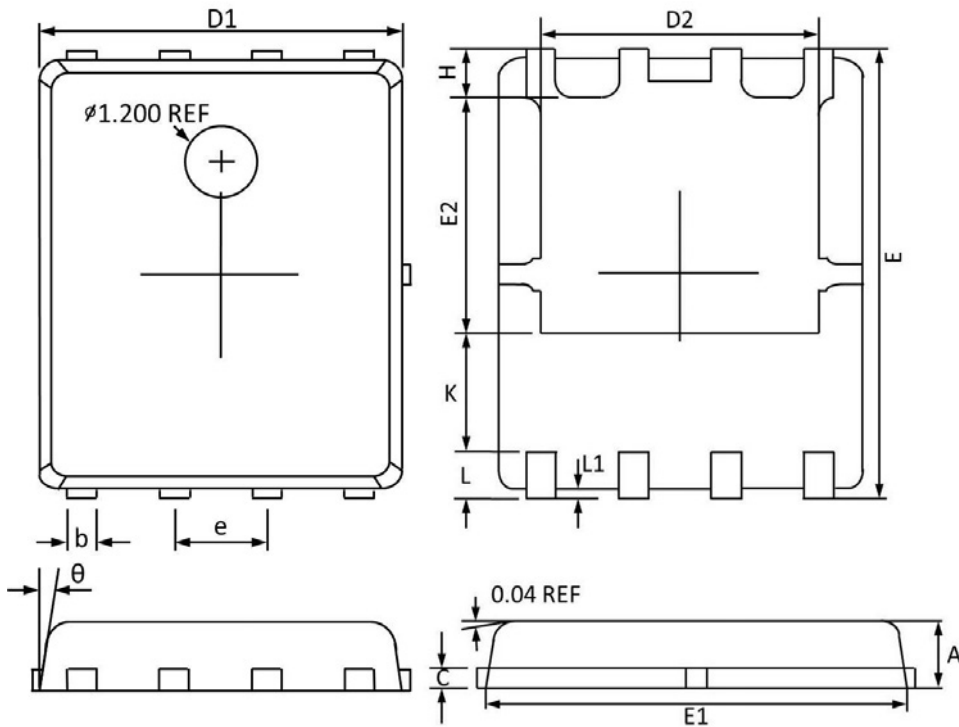


Fig.8 Gate Charge Waveform

Package Outline Dimensions

PPAK5X6



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.100	0.800	0.043	0.031
b	0.510	0.330	0.020	0.013
C	0.300	0.200	0.012	0.008
D1	5.100	4.800	0.201	0.189
D2	4.100	3.610	0.161	0.142
E	6.200	5.900	0.244	0.232
E1	5.900	5.700	0.232	0.224
E2	3.780	3.350	0.149	0.132
e	1.27BSC		0.05BSC	
H	0.700	0.410	0.028	0.016
K	1.500	1.100	0.059	0.043
L	0.710	0.510	0.028	0.020
L1	0.200	0.060	0.008	0.002
θ	12°	0°	12°	0°